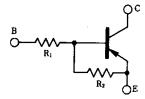
COMPOUND TRANSISTOR HR1 SERIES

on-chip resistor PNP silicon epitaxial transistor For mid-speed switching

FEATURES

NEC

- Up to 2A high current drives such as IC outputs and actuators available
- On-chip bias resistor
- · Low power consumption during drive



HR1 SERIES LISTS

Products	Marking	R1 (KΩ)	R₂ (KΩ)
HR1A3M	MP	1.0	1.0
HR1F3P	MQ	2.2	10
HR1L3N	MR	4.7	10
HR1A4,	MS	10	10
HR1L2Q	MT	0.47	4.7
HR1F2Q	MU	0.22	2.2
HR1A4A	MX	_	10

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

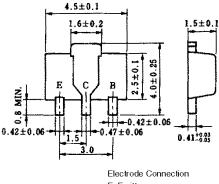
Parameter	Symbol	Ratings	Unit
Collector to base voltage	Vсво	-60	V
Collector to emitter voltage	VCEO	-60	V
Emitter to base voltage	Vebo	-10	V
Collector current (DC)	IC(DC)	-1.0	А
Collector current (Pulse)	IC(pulse) *	-2.0	А
Base current (DC)	B(DC)	-0.02	А
Total power dissipation	P ⊤ **	2.0	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	–55 to +150	°C

* PW \leq 10 ms, duty cycle \leq 50 %

** When 0.7 mm \times 16 cm² ceramic board is used

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PACKAGE DRAWING (UNIT: mm)



E: Emitter C: Collector (Fin) B: Base

HR1A3M ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = -60 \text{ V}, \text{ Ie} = 0$			-100	nA
DC current gain	hfe1 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$	50			-
DC current gain	hfe2 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$	100			_
DC current gain	hfe3 **	Vce = -2.0 V, Ic = -1.0 A	50			_
Low level output voltage	Vol **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.4 \text{ A}$			-0.4	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R1		0.7	1.0	1.3	kΩ
E-to-B resistance	R2		0.7	1.0	1.3	kΩ

** PW \leq 350 μ s, duty cycle \leq 2 %

HR1F3P ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = -60 \text{ V}, I_E = 0$			-100	nA
DC current gain	hfe1 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$	150			-
DC current gain	hfe2 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$	100			_
DC current gain	hfe3 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -1.0 \text{ A}$	50			-
Low level output voltage	Vol **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.3 \text{ A}$			-0.3	V
Low level input voltage	Vı∟ **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R1		1.54	2.2	2.86	kΩ
E-to-B resistance	R2		7	10	13	kΩ

** PW \leq 350 μ s, duty cycle \leq 2 %

HR1L3N ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = -60 \text{ V}, I_E = 0$			-100	nA
DC current gain	hfe1 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$	150			-
DC current gain	hfe2 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$	100			-
DC current gain	hfe3 **	Vce = -2.0 V, Ic = -1.0 A	50			-
Low level output voltage	Vol **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.2 \text{ A}$			-0.3	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R1		3.29	4.7	6.11	kΩ
E-to-B resistance	R2		7	10	13	kΩ

** PW \leq 350 μ s, duty cycle \leq 2 %

HR1A4M ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = -60 \text{ V}, \text{ Ie} = 0$			-100	nA
DC current gain	hfe1 **	Vce = -2.0 V, Ic = -0.1 A	150			-
DC current gain	hfe2 **	Vce = -2.0 V, Ic = -0.5 A	100			-
DC current gain	hfe3 **	Vce = -2.0 V, lc = -1.0 A	50			-
Low level output voltage	V OL **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$			-0.2	V
Low level input voltage	Vı∟ **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	Rı		7	10	13	kΩ
E-to-B resistance	R ₂		7	10	13	kΩ

** PW \leq 350 μ s, duty cycle \leq 2 %

HR1L2Q

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = -60 \text{ V}, I_E = 0$			-100	nA
DC current gain	hfe1 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$	150			-
DC current gain	hfe2 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$	100			-
DC current gain	hfe3 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -1.0 \text{ A}$	50			-
Low level output voltage	Vol **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$			-0.55	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R1		329	470	611	Ω
E-to-B resistance	R2		3.29	4.7	6.11	kΩ

** PW \leq 350 μ s, duty cycle \leq 2 %

HR1F2Q ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = -60 \text{ V}, \text{ I}_{E} = 0$			-100	nA
DC current gain	hfe1 **	Vce = -2.0 V, Ic = -0.1 A	100			_
DC current gain	hfe2 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$	100			-
DC current gain	hfe3 **	Vce = -2.0 V, Ic = -1.0 A	50			-
Low level output voltage	Vol **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$			-0.55	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R1		154	220	286	kΩ
E-to-B resistance	R₂		1.54	2.2	2.86	kΩ

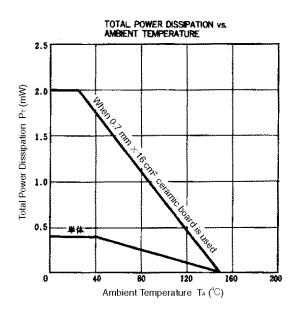
** PW \leq 350 μ s, duty cycle \leq 2 %

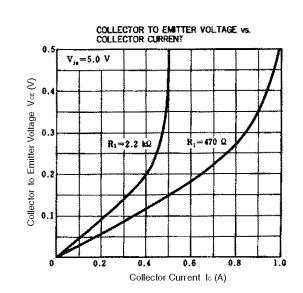
HR1A4A ELECTRICAL CHARACTERISTICS (Ta = 25°C)

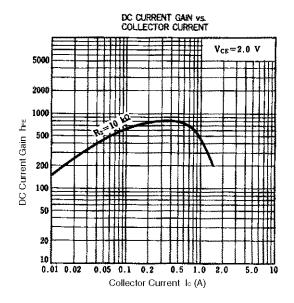
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = -60 \text{ V}, \text{ Ie} = 0$			-100	nA
DC current gain	hfe1 **	$V_{CE} = -2.0 V$, $I_C = -0.1 A$	150			-
DC current gain	hfe2 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$	100			-
DC current gain	hfe3 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -1.0 \text{ A}$	50			-
Collector saturation voltage	VCE(sat) **	$I_{C} = -500 \text{ mA}, I_{B} = -10 \text{ mA}$		0.20	0.35	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$	-0.3		-1.5	V
Input resistance	Rı		-	_	_	Ω
E-to-B resistance	R2		7	10	13	kΩ

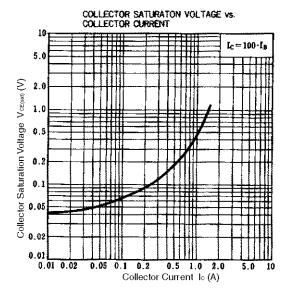
** PW \leq 350 μ s, duty cycle \leq 2 %

TYPICAL CHARACTERISTICS (Ta = 25°C)









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